

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	GILBERT S. Z. LEE	11/22/2022
<b>RECEIVING PARTY DATA</b>		
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<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	17992112
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<b>DATE SIGNED:</b>	11/22/2022	
<b>Total Attachments: 1</b>		
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**ASSIGNMENT**

**INVENTOR  
AND CITY**

Whereas, I, **Gilbert S. Z. Lee** residing at  
**827-1403 Hyundai APT, 101, Jangmi-ro, Bundang-gu, Seongnam-si,  
Gyeonggi-do, Republic of Korea 13499**

have invented:

**TITLE:**

**LINEAR DISCRETE RDSON TEMPERATURE VGS  
COMPENSATION**

**DATE INVENTOR  
SIGNED THE  
DECLARATION**

and executed a United States patent application therefor

on \_\_\_\_\_, 2022, Said assignor hereby authorize and request  
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,  
California, to insert here in parentheses (Application number  
17/992,112, filed November 22, 2022) the filing  
date and application number of said application when known.

Whereas, **Alpha and Omega Semiconductor International LP**, a  
Canadian Corporation, having its registered address at 100 King Street  
West, Suite # 6000, Toronto, Canada M5X 1E2, (hereinafter called **AOS**),  
desires to acquire the entire right, title and interest of said application and  
invention, and to any United States and foreign patents to be obtained  
therefore;

Now therefore for a valuable consideration, receipt whereof is  
hereby acknowledged, I, the above named, hereby sell, assign, and transfer  
to **AOS**, its successors and assigns, the entire right, title and interest in the  
said application and invention therein disclosed for the United States and  
foreign countries, and all rights of priority resulting from the filing said  
United States application, and I request the Commissioner of Patents to  
issue any Letters Patent granted upon the invention set forth in said  
application to **AOS** its successors and assigns; and I hereby agree that  
**AOS** may apply for foreign Letters Patent on said invention and I will  
execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by

**CITY AND**

Signed and Sealed at Bundang-gu, Seongnam-si, Gyeonggi-do, ROK

**DATE**

on Nov. 22th, 2022



**Gilbert S. Z. Lee**